

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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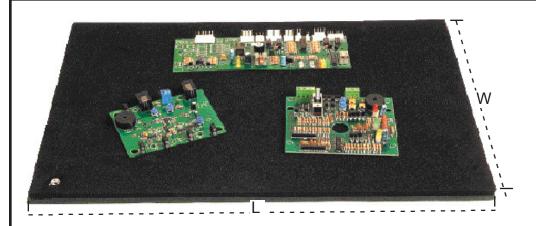
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SPECIFICATIONS FOR CORRUGATED MATERIAL:

Properties Electrostatic Decay Surface Resistance

High-Voltage Discharge Resistance

Static Shielding

Charged Device Model (CDM) Safety

Corrosivity

Sloughing Test

Recyclability Biodegradability **Volume Conductivity**

Shelf Life

Typical Values

0.01 seconds at 72°F and 11.8% R.H.

10E6 - 10E8 ohms/sq. after 11 days at 68°F and 12% R.H. for surface. 10E3 - 10E4 ohms/sq. for buried shielding layer Failure rate 0/5 (no oxide damage in five consecutive tests) 99.9% attenuation at 10kV: 99.6% attenuation at 30kV

RTG >10E7 ohms at 86% R.H. or less Contains 1-3 ppm reducible sulfur

Negligible surface damage at 10 cycles and <5% of surface

damage at 200 cycles in Taber Abrasion Test. No conductive particles abrased from surface

Complete recyclability of package Biodegradation in or on moist soil

Conductivity from wall to wall as well as across surface

to assure permanence of the antistatic property

Indefinite

SPECIFICATIONS FOR FOAM:

Property Test Method Results 1.9 lb/ft³ Density ASTM D3575-91 **Surface Resistivity** EOS/ESD DS111-1993 TS 1021BA (UK MOD) Pass Corrosivity

Water Extract TS 1021BA (UK MOD) **Total Chlorine** TS 1021BA (UK MOD)

Internal

Recommended Operating Temperature Range

Tear Strength ASTM D3575-91 ASTM D2575-91 **Tensile Strength**

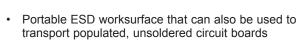
10E7 - 10E9 ohms/sq

Pass Pass

+200°F to -95°F

14 lbf/in 44 psi

Features





- Static dissipative foam (RTT 10E6 10E8 ohms) laminated to Protektive Pak® impregnated corrugated material for greater durability
- Foam is shuntable, component leads can be kept at equipotential and more stable when moved
- Includes 10mm (3/8") grounding snap
- Static dissipative material 10E6 10E8 ohms
- Buried shielding layer minimizes sloughing and rub-off contamination
- Made in America

Test Procedures/Method

FED-STD-101. Method 4046

ASTM D257

Rockwell International Test Report of December 20, 1991

EIA 541, appendix E. capacitive probe test

Rockwell International Test Report of December 20, 1991

FED-STD-101, Method 3005 for reducible sulfur ASTM D4060 at 70 rpm with CS-17 abrasive-coated wheels and 1000 grams load

Rockwell International Test Report of January 8, 1992 Rockwell International Test Report of January 8, 1992

Rockwell International Test Report of January 8, 1992

*Colour and texture may vary between lots and mills

Item No.	Size - L x W	Snap
37800	12 x 18	Male
39852	12 x 18	Female
37801	18 x 24	Male
39854	18 x 24	Female



TEK-MATE™ BOARD HANDLERS

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PROTEKTIVE PAK

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DRAWING NUMBER 37800

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